

## **Quarterly Reliability Monitoring Results**

## Quarters: Q1/2022 to Q4/2023

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory Assembly reliability labs		User Part Number PNE20040EP Part Description										
								Nexperia DHAM Rectifier				
								SMD package				
		Test		Test Conditions	Duration	# Lots	# Quantity	# Rejects				
			TEST									
	Pre- and Post-Stress											
# 1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below						
		JESD22-A113 Bake Tamb = 125 °C	24 hours									
	PC	Soak Tamb = 125 °C, RH = 85%	168 hours									
# 2	Preconditioning	Reflow soldering	3 cycles	1514	64430	0						
	<del>-</del>	MIL-STD-750-1				-						
	HTRB	M1038 Method A										
	High Temperature Reverse	Tj = Tjmax, Vr = 100% of max. datasheet										
# 5	Bias	reverse voltage	1000 hours	40	1840	0						
		350000 4404										
	TC Temperature Cycling	JESD22-A104 -65 °C to Timax, not to exceed 150°C	F00	211	1 4000	0						
# 7	remperature cycling	-03 C to filliax, flot to exceed 150 C	500 cycles	311	14080	0						
	UHAST	JESD22-A118										
# 8 <b>o</b> r	Unbiased HAST	Tamb = 130 °C, RH = 85 %		311	14080	0						
		JESD22-A102	— 96 hours									
	AC	Tamb = 121 °C, RH = 100 %										
# 8a	Autoclave	Pressure = 205 kPa (29.7 psia)										
		JECD22 A101										
	H3TRB	JESD22-A101 Tamb = 85 °C, RH = 85%, VR = 80 % of										
# 9	High Humidity High Temperature Reverse Bias	rated reverse voltage <sup>[1]</sup>	1000 hours	311	14080	0						
# 9	. c. iiperatare iteverse blas	MIL-STD-750 Method 1037	1000 Hours	711	14000	U						
	IOL	ton = toff, devices powered to insure $\Delta T_j$ =										
# 10	Intermittent Operating Life		333 hours	312	14120	0						
	RSH	JESD22-A111										
# 20	Resistance to Solder Heat	260 °C ± 5 °C	10 s	269	8070	0						
	SD Caldanahilib	1 CTD 003										
# 21	Solderability	J-STD-002	445)	222	6660	0						

<sup>[1]</sup> The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

## **Calculation of FIT and MTTF**

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test # 5)
Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
Nexperia					
DHAM	Rectifier	1840	0	2,31	4,33E+08

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